

RE01FGC

May 2 2025

16 Position Gray Code Rotary Encoder

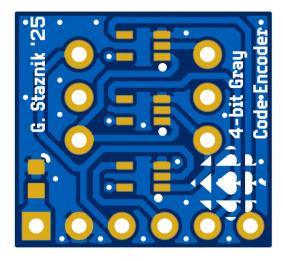
FEATURES

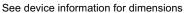
- 16 Rotary Positions with Discrete Mechanical Detents
- Accepts 1.65 V up to 5 V Logic Levels
- Breadboard Compatible
- Robust and Simple Output
- Quick Computation of Gray Code
- Integrated Decoupling Capacitor
- Compact 15x14 mm Size
- Cheap Manufacturing
- Manually Manufacturable

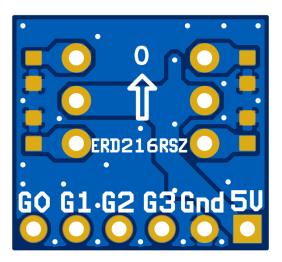
DESCRIPTION

The RE01FGC is a compact, 16-position Gray Code rotary encoder module. It converts a 4-bit binary value generated by an onboard rotary switch into a 4-bit Gray Code output using three integrated XOR gates. The resulting output provides robust and clean signals, ideal for breadboard prototyping.

The module is designed to operate at 1.65 V and up to 5V logic levels, with clean signal transitions and convenient breadboard pin spacing, making it ideal for rapid prototyping and educational purposes. Each position on the rotary switch corresponds to a unique value in Gray Code value.









Device Overview

 Texas Instruments SN74LVC1G86DCKR XOR Gate https://www.lcsc.com/datasheet/lcsc datasheet 2410121946 Texas-Instruments-SN74LVC1G86DCKR C52350.pdf

ECE ERD216RSZ 16 Position Rotary Encoder
https://www.lcsc.com/datasheet/lcsc datasheet 2410241443 ECEERD216RSZ C40425407.pdf

When choosing capacitors and resistors, ensure power ratings are adequate for their functions on the device. The 5 V limit is due to the XOR Gates.

Logic Diagrams

Truth Table:

| Bin3 | Bin2 | Bin1 | Bin0 | GC3 | GC2 | GC1 | GC0 |
|------|------|------|------|-----|-----|-----|-----|
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 0 | 0 | 1 | 0 | 0 | 0 | 1 |
| 0 | 0 | 1 | 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 1 | 1 | 0 | 0 | 1 | 0 |
| 0 | 1 | 0 | 0 | 0 | 1 | 1 | 0 |
| 0 | 1 | 0 | 1 | 0 | 1 | 1 | 1 |
| 0 | 1 | 1 | 0 | 0 | 1 | 0 | 1 |
| 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 |
| 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0 |
| 1 | 0 | 0 | 1 | 1 | 1 | 0 | 1 |
| 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1 |
| 1 | 0 | 1 | 1 | 1 | 1 | 1 | 0 |
| 1 | 1 | 0 | 0 | 1 | 0 | 1 | 0 |
| 1 | 1 | 0 | 1 | 1 | 0 | 1 | 1 |
| 1 | 1 | 1 | 0 | 1 | 0 | 0 | 1 |
| 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |

Boolean Expressions:

 $GC0 = BIN0 \oplus BIN1$

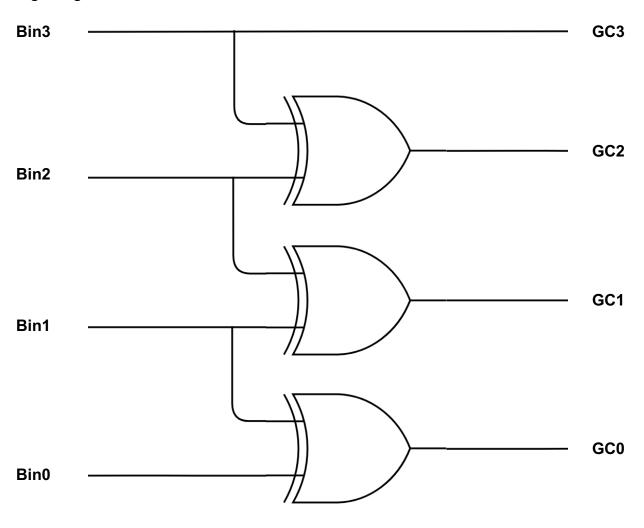
 $GC1 = BIN1 \oplus BIN2$

 $GC2 = BIN2 \oplus BIN3$

GC3 = BIN3



Logic Diagram:

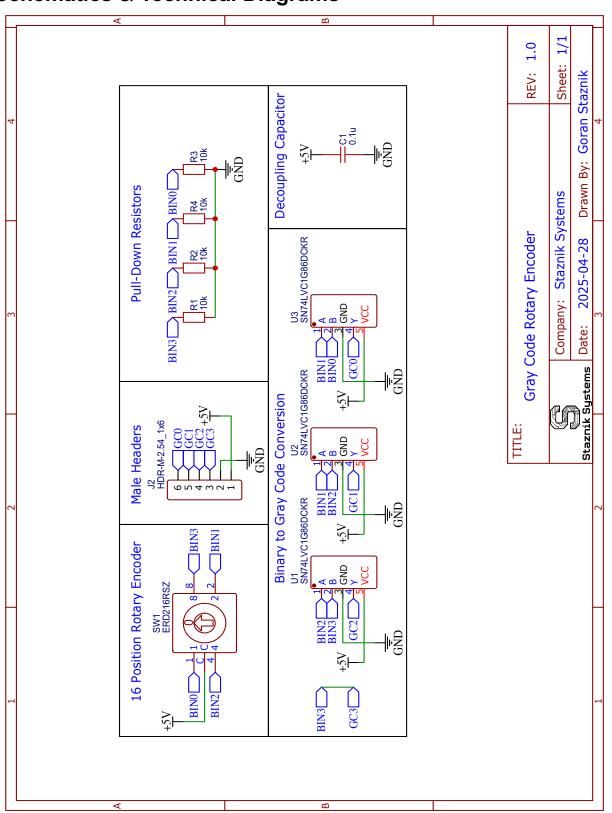


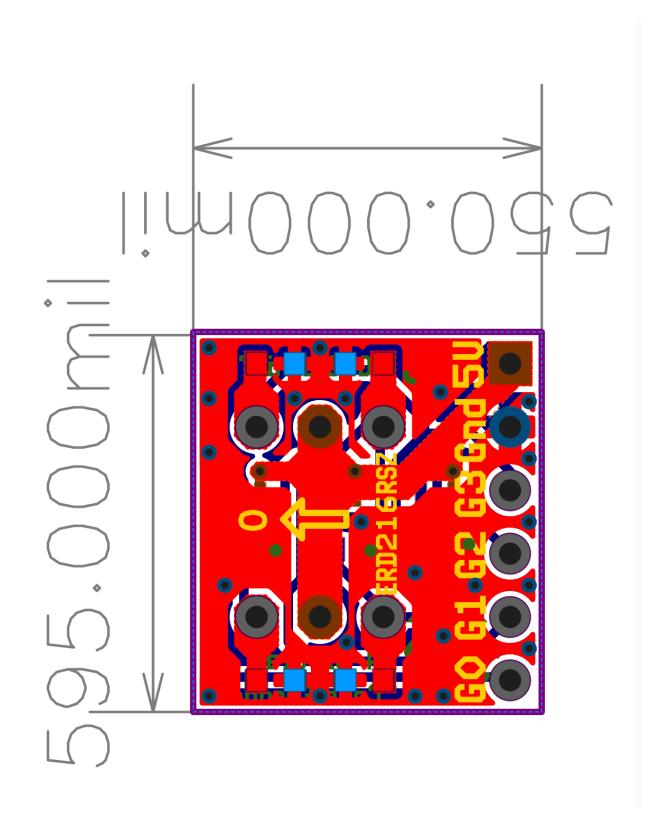
Electrical Characteristics

| | Min | Тур. | Max | Unit |
|---------------------------------------|------|------|----------|------|
| V _{cc} Input & Logic Voltage | 1.65 | - | 5 | V |
| V₀ Output Voltage | 0 | - | V_{cc} | V |
| I _{out} Output Current | 0 | - | 50 | mA |
| tpd Switching time (5V) | 1 | - | 4 | ns |
| Δt/ΔV Input Rise/Fall Time (5V) | | 5 | | ns/V |
| T _A Operating Temperate | -4 | 25 | 125 | °C |

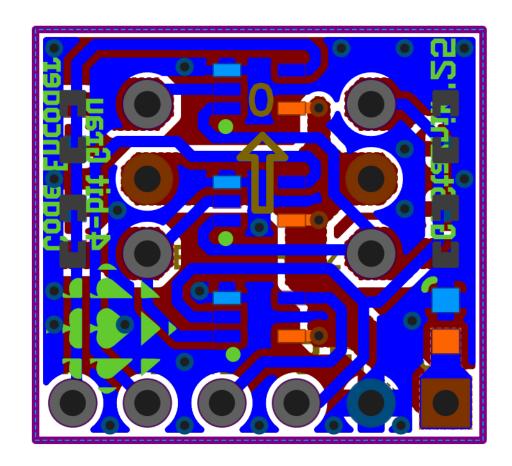


Schematics & Technical Diagrams

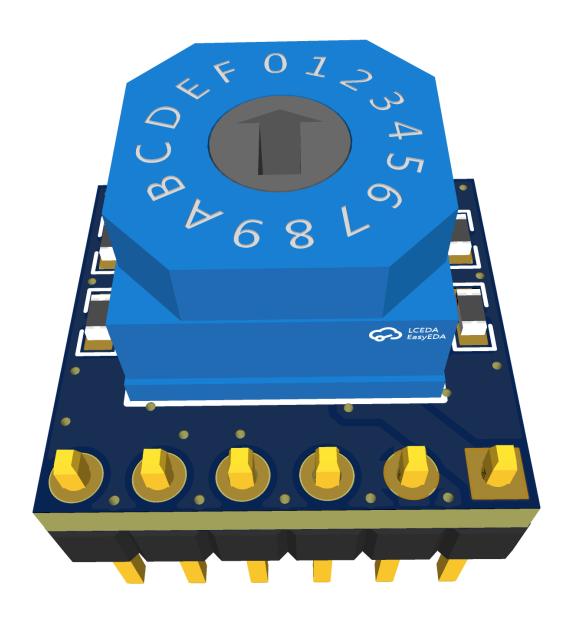












Note the silkscreen is different on the final product



Ordering Information

The RE01FGC was designed with the express purpose of ease and low cost of manufacture. All parts were ensured to be available on LCSC.

Below are the specifications that are required to produce the RE01FGC PCB:

| | Spec. | Unit |
|------------------------------------|-------|------|
| Minimum Trace clearance | 0.6 | mm |
| Minimum Trace Width | 6 | mil |
| Minimum Via Drill Size | 0.3 | mm |
| Via Hole to Hole Spacing | 0.6 | mm |
| Trace/Via to Copper Pour Clearance | 0.6 | mm |
| Minimum Character Width | 6 | mil |

Here are the specifications when producing or ordering the PCB:

| | Spec. | Unit |
|---------------------|---------|------|
| PCB Layers | 2 | |
| Board Material | FR-4 | |
| Board Thickness* | 0.6 | mm |
| Board Dimensions | 595x550 | mil |
| Colour | | |
| Surface Finish** | | |
| Outer Copper Weight | 1 | OZ |
| Via Coverings | | |

^{*}Other thicknesses are acceptable, though it is recommended to keep the board thin for better grounding with the ground pours.

When manufacturing the PCB, ensure that all components are correctly placed, and the direction of the XOR ICs are correct. Also ensure that the chosen parts match the specifications.

^{**}Surface finish can be determined by the user, however, ENIG is recommended for applications requiring stocking the un-manufactured PCB for long periods of time. Tough HASL is acceptable in most cases.



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